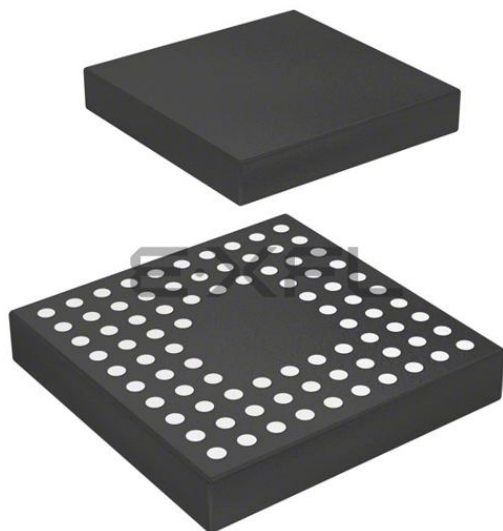




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Details

Product Status	Obsolete
Core Processor	M16C/60
Core Size	16-Bit
Speed	20MHz
Connectivity	I ² C, IEBus, SIO, UART/USART
Peripherals	DMA, POR, PWM, Voltage Detect, WDT
Number of I/O	71
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 24x10b
Oscillator Type	Internal
Operating Temperature	-20°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	85-TFLGA
Supplier Device Package	85-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30280f8wg-u9b

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1.3 Block Diagram

Figure 1.1 is a block diagram of the M16C/28 Group (M16C/28, M16C/28B), 80-pin and 85-pin package.

Figure 1.2 is a block diagram of the M16C/28 Group (M16C/28, M16C/28B), 64-pin package.

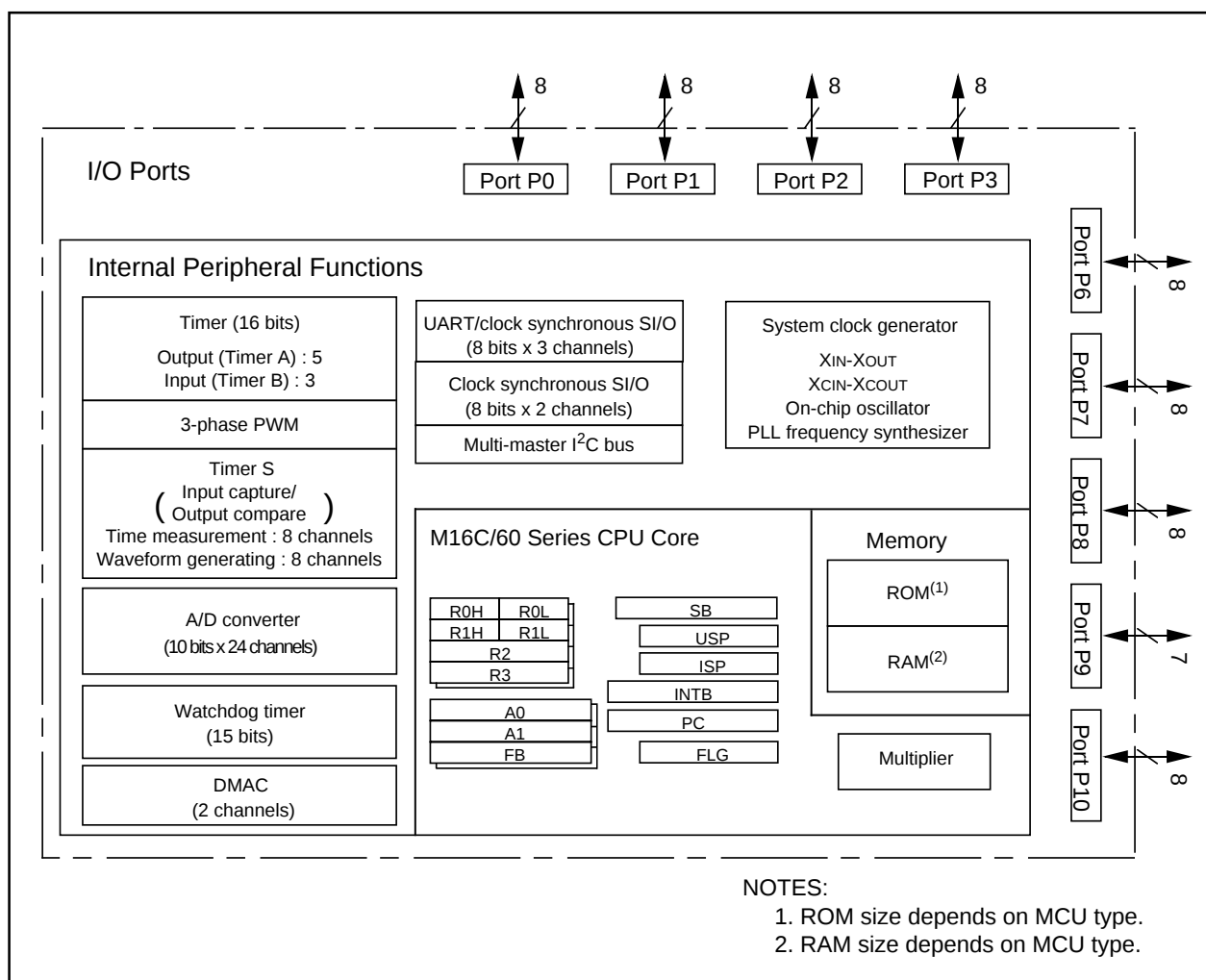


Figure 1.1 M16C/28 Group (M16C/28, M16C/28B), 80-Pin/85-Pin Block Diagram

1.4 Product Information

Tables 1.3 and 1.4 list the M16C/28 Group product information and Figure 1.3 shows the product numbering system. The specifications are partially different between normal-ver. and T/ V-ver..

Table 1.3 M16C/28 Product List -Normal-ver.

As of September, 2006

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30280F6WG (N)	48 K + 4 K	4 K	PTLG0085JB-A (85F0G)	Flash Memory	U3, U5, U7, U9
M30280F8WG (N)	64 K + 4 K	4 K			
M30280FAWG (N)	96 K + 4 K	8 K			
M30280F6HP (N)	48 K + 4 K	4 K	PLQP0080KB-A (80P6Q-A)		
M30280F8HP (N)	64 K + 4 K	4 K			
M30280FAHP (N)	96 K + 4 K	8 K			
M30280FCHP (N)	128 K + 4 K	12 K			
M30281F6HP (N)	48 K + 4 K	4 K	PLQP0064KB-A (64P6Q-A)		
M30281F8HP (N)	64 K + 4 K	4 K			
M30281FAHP (N)	96 K + 4 K	8 K			
M30281FCHP (N)	128 K + 4 K	12 K			
M30280M8-XXXHP (N)	64 K	4 K	PLQP0080KB-A (80P6Q-A)	Mask ROM	U3, U5
M30280MA-XXXHP (N)	96 K	8 K			
M30280MC-XXXHP (N)	128 K	12 K			
M30281M8-XXXHP (N)	64 K	4 K	PLQP0064KB-A (64P6Q-A)		
M30281MA-XXXHP (N)	96 K	8 K			
M30281MC-XXXHP (N)	128 K	12 K			

(N): New

Table 1.4 M16C/28B Product List -Normal-ver.

As of September, 2006

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30280FCBHP (D)	128 K + 4 K	12 K	PLQP0080KB-A (80P6Q-A)	Flash memory	U7
M30281FCBHP (D)	128 K + 4 K	12 K	PLQP0064KB-A (64P6Q-A)		

(D): Under development

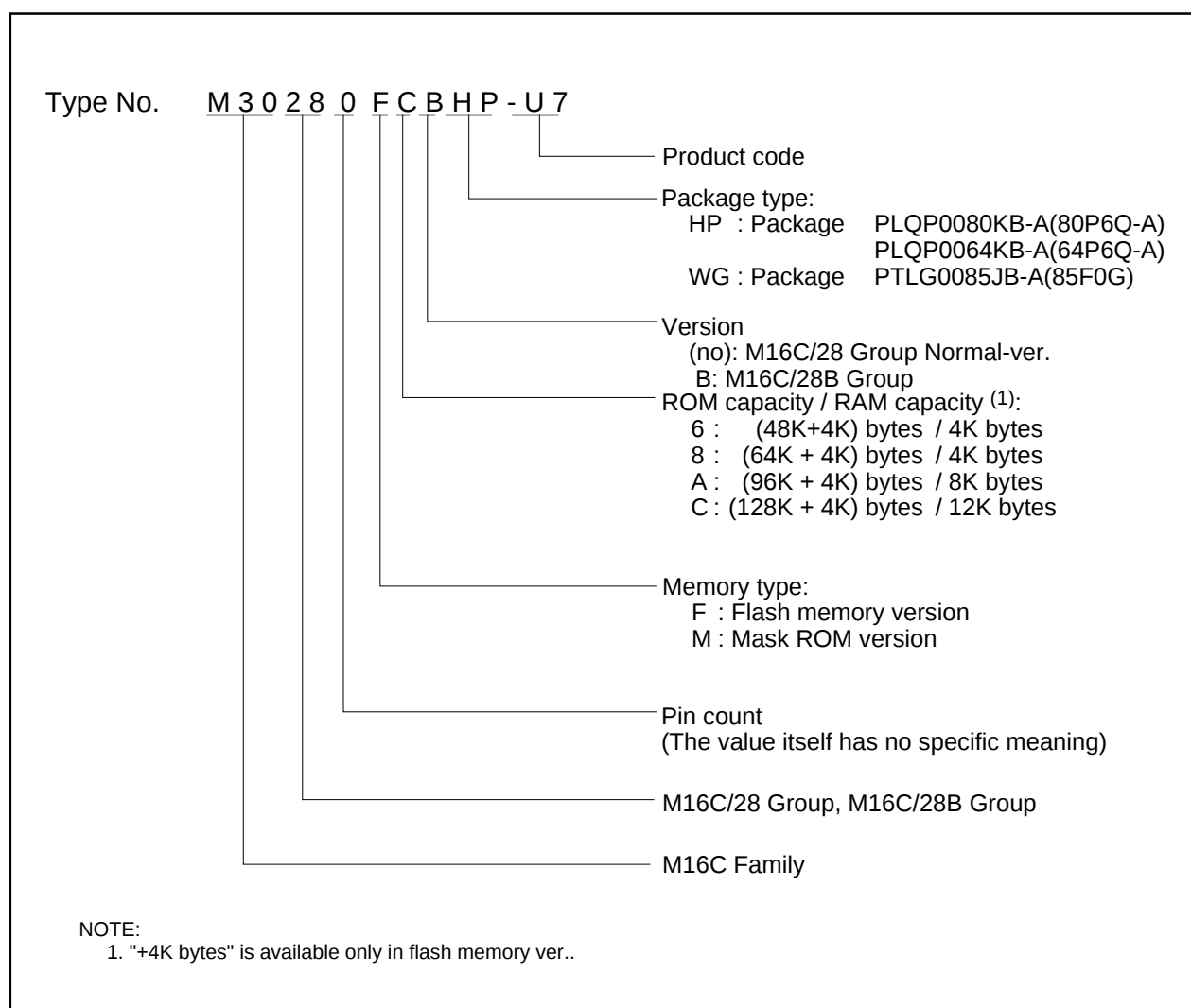
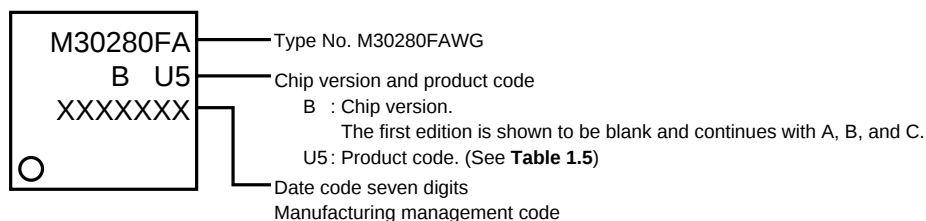


Figure 1.3 Product Numbering System

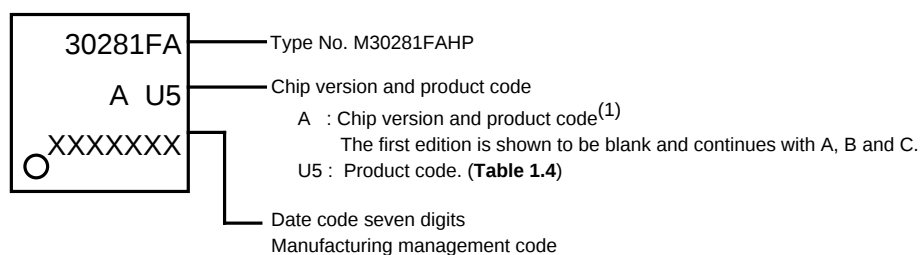
(1) Flash Memory Version, PTLG0085JB-A (85F0G), Normal-ver.



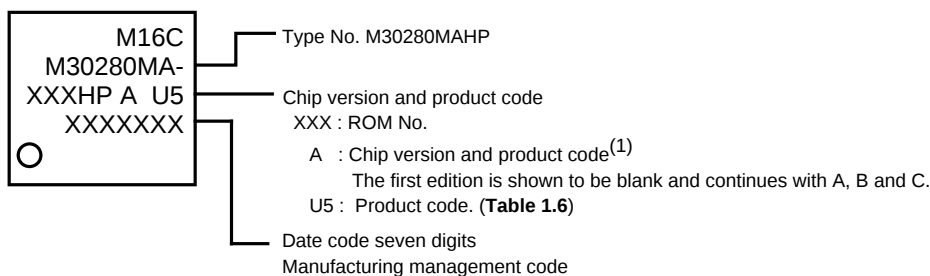
(2) Flash Memory Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



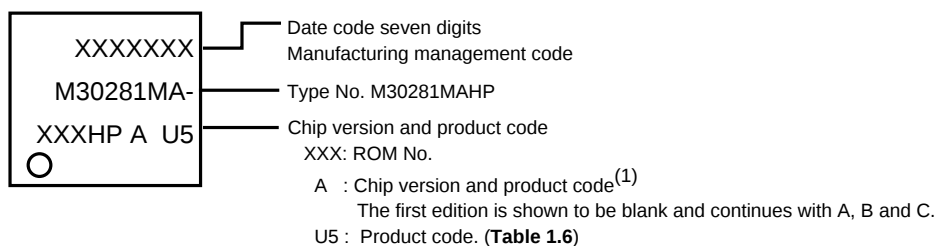
(3) Flash Memory Version, PLQP0064KB-A (64P6Q-A), Normal-ver.



(4) Mask ROM Version, PLQP0080KB-A (80P6Q-A), Normal-ver.



(5) Mask ROM Version, PLQP0064-KB-A (64P6Q-A), Normal-ver.



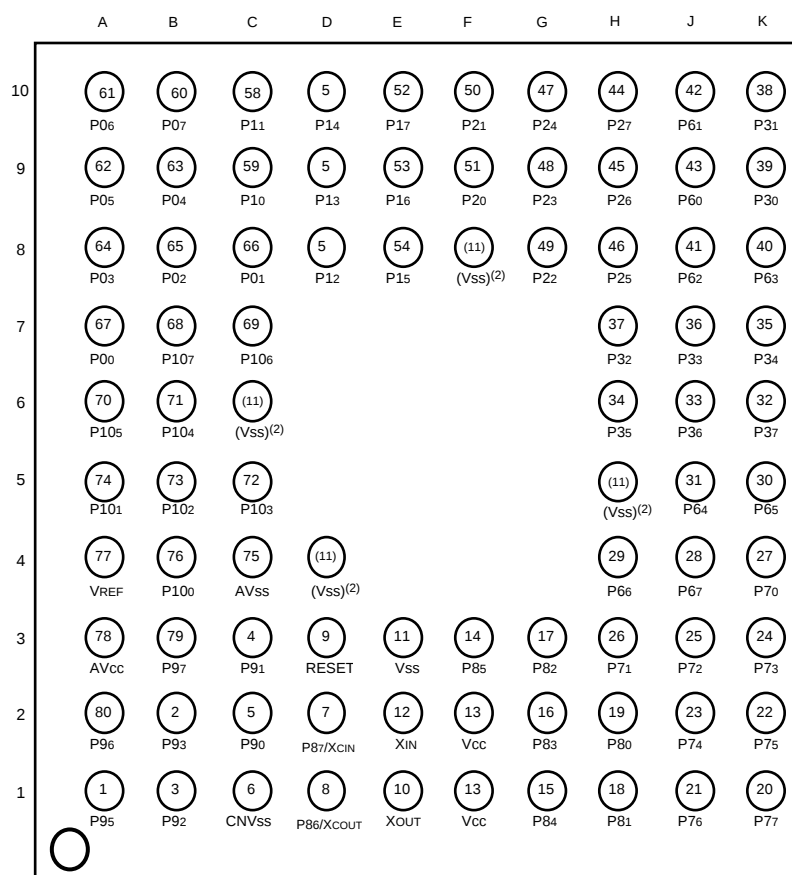
NOTES:

- The following functions are not available in the first version and version A products.
 - Delay trigger mode 0 of A/D conversion
 - Delay trigger mode 1 of A/D conversion

Figure 1.4 Marking Diagram-M16C/28 Normal-ver.

1.5 Pin Assignment

Figures 1.5 to 1.7 show the pin Assignments (top view).



NOTES :

1. The numbers in each grid (circle) show the pin numbers of the M30280FAHP (80P6Q-A package)
2. Connect grids written as (Vss) to Vss(GND) or leave them open.
3. Set PACR2 to PACR0 bits in the PACR register to "0112" before you input and output it after resetting to each pin. When the PACR register is not set, the input and output function of some pins are disabled.

Package: PTLG0085JB-A(85F0G)

Figure 1.5 Pin Assignment (Top View) of 85-pin Package

Table 1.8 Pin Characteristics for 85-pin Package (continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin	PLQP0080KB-A Pin Number
E8		P15	$\overline{\text{INT}}_3$	IDV				ADTRG	54
E9		P16	$\overline{\text{INT}}_4$	IDW					53
E10		P17	$\overline{\text{INT}}_5$	IDU	INPC17				52
F1	Vcc								13
F2	Vcc								13
F3		P85	$\overline{\text{NMI}}$	$\overline{\text{SD}}$					14
F8	Vss ⁽¹⁾								(11)
F9		P20			OUTC10 / INPC10		SDAMM		51
F10		P21			OUTC11 / INPC11		SCLMM		50
G1		P84	$\overline{\text{INT}}_2$	ZP					15
G2		P83	$\overline{\text{INT}}_1$						16
G3		P82	$\overline{\text{INT}}_0$						17
G8		P22			OUTC12 / INPC12				49
G9		P23			OUTC13 / INPC13				48
G10		P24			OUTC14 / INPC14				47
H1		P81		TA4IN / $\overline{\text{U}}$					18
H2		P80		TA4OUT / U					19
H3		P71		TA0IN		RxD2 / SCL2 / CLK1			26
H4		P66				RxD1			29
H5	Vss ⁽¹⁾								(11)
H6		P35							34
H7		P32				SOUT3			37
H8		P25			OUTC15 / INPC15				46
H9		P26			OUTC16 / INPC16				45
H10		P27			OUTC17 / INPC17				44
J1		P76		TA3OUT					21
J2		P74		TA2OUT / W					23
J3		P72		TA1OUT / V		CLK2 / RxD1			25
J4		P67				TxD1			28
J5		P64				RTS1 / CTS1 / CTS0 / CLKS1			31
J6		P36							33
J7		P33							36
J8		P62				RxD0			41
J9		P60				RTS0 / CTS0			43
J10		P61				CLK0			42
K1		P77		TA3IN					20
K2		P75		TA2IN / $\overline{\text{W}}$					22
K3		P73		TA1IN / $\overline{\text{V}}$		CTS2 / RTS2 / TxD1			24
K4		P70		TA0OUT		TxD2 / SDA2 / RTS1 / CTS1 / CTS0 / CLKS1			27
K5		P65				CLK1			30
K6		P37							32
K7		P34							35
K8		P63				TxD0			40
K9		P30				CLK3			39
K10		P31				SIN3			38

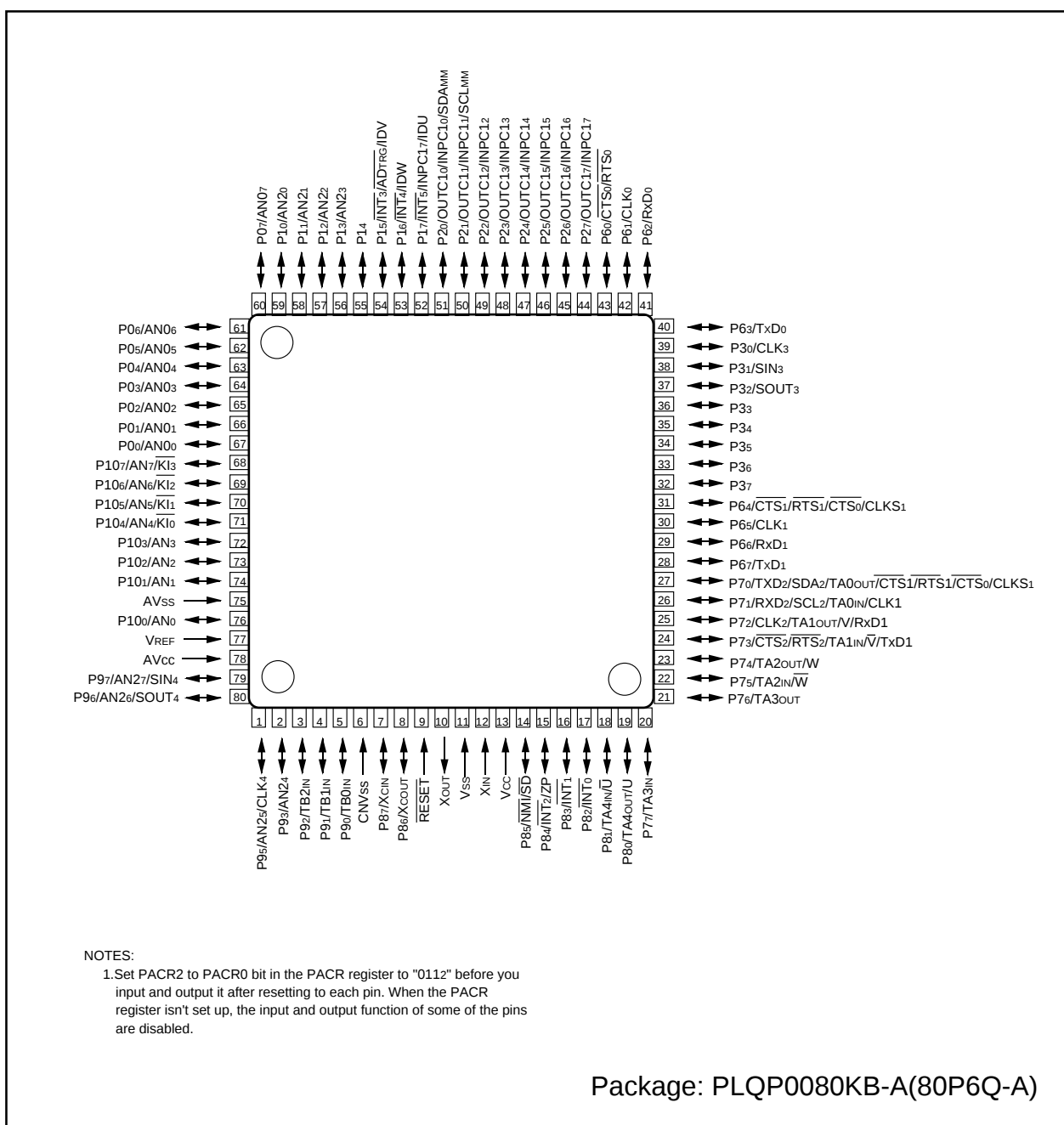


Figure 1.5 Pin Assignment (Top View) of 80-Pin Package

Table 1.9 Pin Characteristics for 80-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin
41		P62				RxD0		
42		P61				CLK0		
43		P60				$\overline{\text{RTS}}_0 / \overline{\text{CTS}}_0$		
44		P27			OUTC17 / INPC17			
45		P26			OUTC16 / INPC16			
46		P25			OUTC15 / INPC15			
47		P24			OUTC14 / INPC14			
48		P23			OUTC13 / INPC13			
49		P22			OUTC12 / INPC12			
50		P21			OUTC11 / INPC11		SCLMM	
51		P20			OUTC10 / INPC10		SDAMM	
52		P17	$\overline{\text{INT}}_5$	IDU	INPC17			
53		P16	$\overline{\text{INT}}_4$	IDW				
54		P15	$\overline{\text{INT}}_3$	IDV				$\overline{\text{ADTRG}}$
55		P14						
56		P13						AN23
57		P12						AN22
58		P11						AN21
59		P10						AN20
60		P07						AN07
61		P06						AN06
62		P05						AN05
63		P04						AN04
64		P03						AN03
65		P02						AN02
66		P01						AN01
67		P00						AN00
68		P107	$\overline{\text{KI}}_3$					AN7
69		P106	$\overline{\text{KI}}_2$					AN6
70		P105	$\overline{\text{KI}}_1$					AN5
71		P104	$\overline{\text{KI}}_0$					AN4
72		P103						AN3
73		P102						AN2
74		P101						AN1
75	AVss							
76		P100						AN0
77	VREF							
78	AVcc							
79		P97				SIN4		AN27
80		P96				SOUT4		AN26

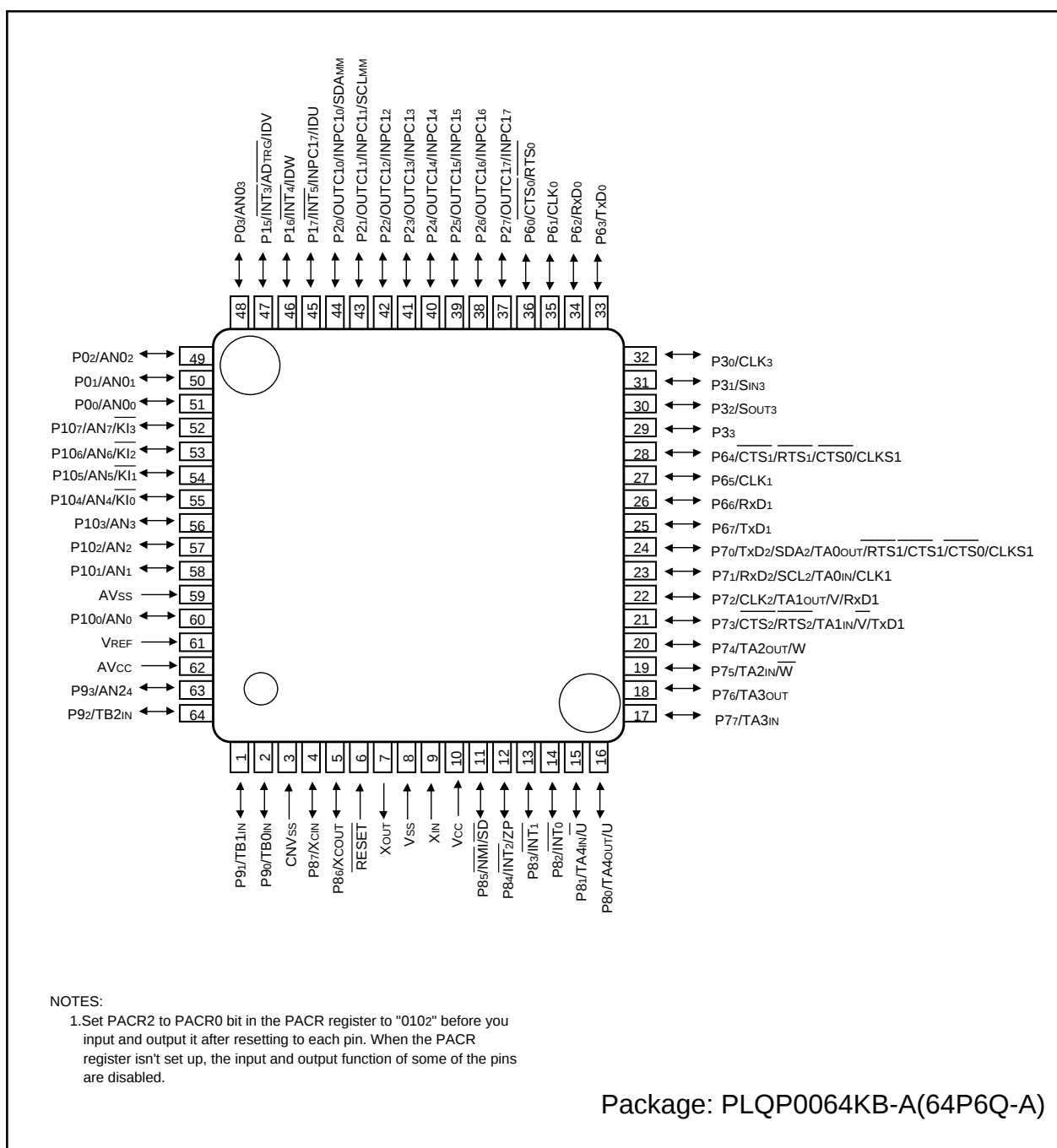


Figure 1.6 Pin Assignment (Top View) of 64-Pin Package

Table 1.10 Pin Characteristics for 64-Pin Package

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin
1		P91		TA1IN				
2		P90		TB0IN				
3	CNVss							
4	XCIN	P87						
5	XCOUT	P86						
6	RESET							
7	XOUT							
8	Vss							
9	XIN							
10	Vcc							
11		P85	NMI	SD				
12		P84	INT ₂	ZP				
13		P83	INT ₁					
14		P82	INT ₀					
15		P81		TA4IN / $\bar{U}$				
16		P80		TA4OUT / U				
17		P77		TA3IN				
18		P76		TA3OUT				
19		P75		TA2IN / $\bar{W}$				
20		P74		TA2OUT / W				
21		P73		TA1IN / $\bar{V}$		CTS ₂ / $\bar{RTS}_2$ / TxD ₁		
22		P72		TA1OUT / V		CLK ₂ / RxD ₁		
23		P71		TA0IN		RxD ₂ / SCL ₂ / CLK ₁		
24		P70		TA0OUT		TxD ₂ / SDA ₂ / $\bar{RTS}_1$ / CTS ₁ / $\bar{CTS}_0$ / CLK _{S1}		
25		P67				TxD ₁		
26		P66				RxD ₁		
27		P65				CLK ₁		
28		P64				RTS ₁ / CTS ₁ / $\bar{CTS}_0$ / CLK _{S1}		
29		P33						
30		P32				SOUT ₃		
31		P31				SIN ₃		
32		P30				CLK ₃		
33		P63				TxD ₀		
34		P62				RxD ₀		
35		P61				CLK ₀		
36		P60				RTS ₀ / $\bar{CTS}_0$		
37		P27			OUTC17 / INPC17			
38		P26			OUTC16 / INPC16			
39		P25			OUTC15 / INPC15			
40		P24			OUTC14 / INPC14			

Table 10 Pin Characteristics for 64-Pin Package (Continued)

Pin No.	Control Pin	Port	Interrupt Pin	Timer Pin	Timer S Pin	UART Pin	Multi-master I ² C bus Pin	Analog Pin
41		P23			OUTC13 / INPC13			
42		P22			OUTC12 / INPC12			
43		P21			OUTC11 / INPC11		SCLMM	
44		P20			OUTC10 / INPC10		SDAMM	
45		P17	$\overline{\text{INT}}_5$	IDU	INPC17			
46		P16	$\overline{\text{INT}}_4$	IDW				
47		P15	$\overline{\text{INT}}_3$	IDV				$\overline{\text{ADTRG}}$
48		P03						AN03
49		P02						AN02
50		P01						AN01
51		P00						AN00
52		P107	$\overline{\text{KI}}_3$					AN7
53		P106	$\overline{\text{KI}}_2$					AN6
54		P105	$\overline{\text{KI}}_1$					AN5
55		P104	$\overline{\text{KI}}_0$					AN4
56		P103						AN3
57		P102						AN2
58		P101						AN1
59	AVss							
60		P100						AN0
61	VREF							
62	AVcc							
63		P93						AN24
64		P92		TB2IN				

1.6 Pin Description

Table 1.10 Pin Description (64-Pin, 80-Pin and 85-Pin Packages)

Classification	Symbol	I/O Type	Function
Power Supply	VCC, VSS	I	Apply 2.7 to 5.5V to the VCC pin. Apply 0V to the VSS pin.
Analog Power Supply	AVCC AVSS	I	Supplies power to the A/D converter. Connect the AVCC pin to VCC and the AVSS pin to VSS.
Reset Input	RESET	I	The MCU is in a reset state when "L" is applied to the RESET pin
CNVSS	CNVSS	I	Connect the CNVSS pin to VSS.
Main Clock Input	XIN	I	I/O pins for the main clock oscillation circuit. Connect a ceramic resonator or crystal oscillator between XIN and XOUT. To apply external clock, apply it to XIN and leave XOUT open. If XIN is not used (for external oscillator or external clock) connect XIN pin to VCC and leave XOUT open.
Main Clock Output	XOUT	O	
Sub Clock Input	XCIN	I	I/O pins for the sub clock oscillation circuit. Connect a crystal oscillator between XCIN and XCOUT.
Sub Clock Output	XCOUT	O	
INT Interrupt Input	INT0 to INT5	I	Input pins for the INT interrupt. INT2 can be used for Timer A Z-phase function.
NMI Interrupt Input	NMI	I	Input pin for the NMI interrupt. NMI cannot be used as I/O port while the three-phase motor control is enabled. Apply a stable "H" to NMI after setting it's direction register to "0" when the three-phase motor control is enabled.
Key Input Interrupt	KI0 to KI3	I	Input pins for the key input interrupt
Timer A	TA0OUT to TA4OUT	I/O	I/O pins for the timer A0 to A4
	TA0IN to TA4IN	I	Input pins for the timer A0 to A4
	ZP	I	Input pin for Z-phase
Timer B	TB0IN to TB2IN	I	Input pins for the timer B0 to B2
Three-phase Motor Control	U, $\bar{U}$, V, $\bar{V}$, W, $\bar{W}$	O	Output pins for the three-phase motor control timer
Timer Output	IDU, IDW, IDV, $\bar{S}\bar{D}$	I/O	Input and output pins for the three-phase motor control timer
Serial I/O	CTS0 to CTS2	I	Input pins for data transmission control
	RTS0 to RTS2	O	Output pins for data reception control
	CLK0 to CLK3	I/O	Inputs and outputs the transfer clock
	RxD0 to RxD2	I	Inputs serial data
	TxD0 to TxD2	O	Outputs serial data
	CLKS1	O	Output pin for transfer clock
I ² C Mode	SDA2	I/O	Inputs and outputs serial data
	SCL2		Inputs and outputs the transfer clock
Multi-master I ² C bus	SDAMM	I/O	Inputs and outputs serial data
	SCLMM		Inputs and outputs the transfer clock
Reference Voltage Input	VREF	I	Applies reference voltage to the A/D converter
A/D Converter	AN0 to AN7 AN00 to AN03 AN24	I	Analog input pins for the A/D converter
	ADTRG		Input pin for an external A/D trigger

I : Input O : Output I/O : Input and output

2. Central Processing Unit (CPU)

Figure 2.1 shows the CPU registers. The register bank is comprised of 7 registers (R0, R1, R2, R3, A0, A1 and FB) out of 13 CPU registers. Two sets of register banks are provided.

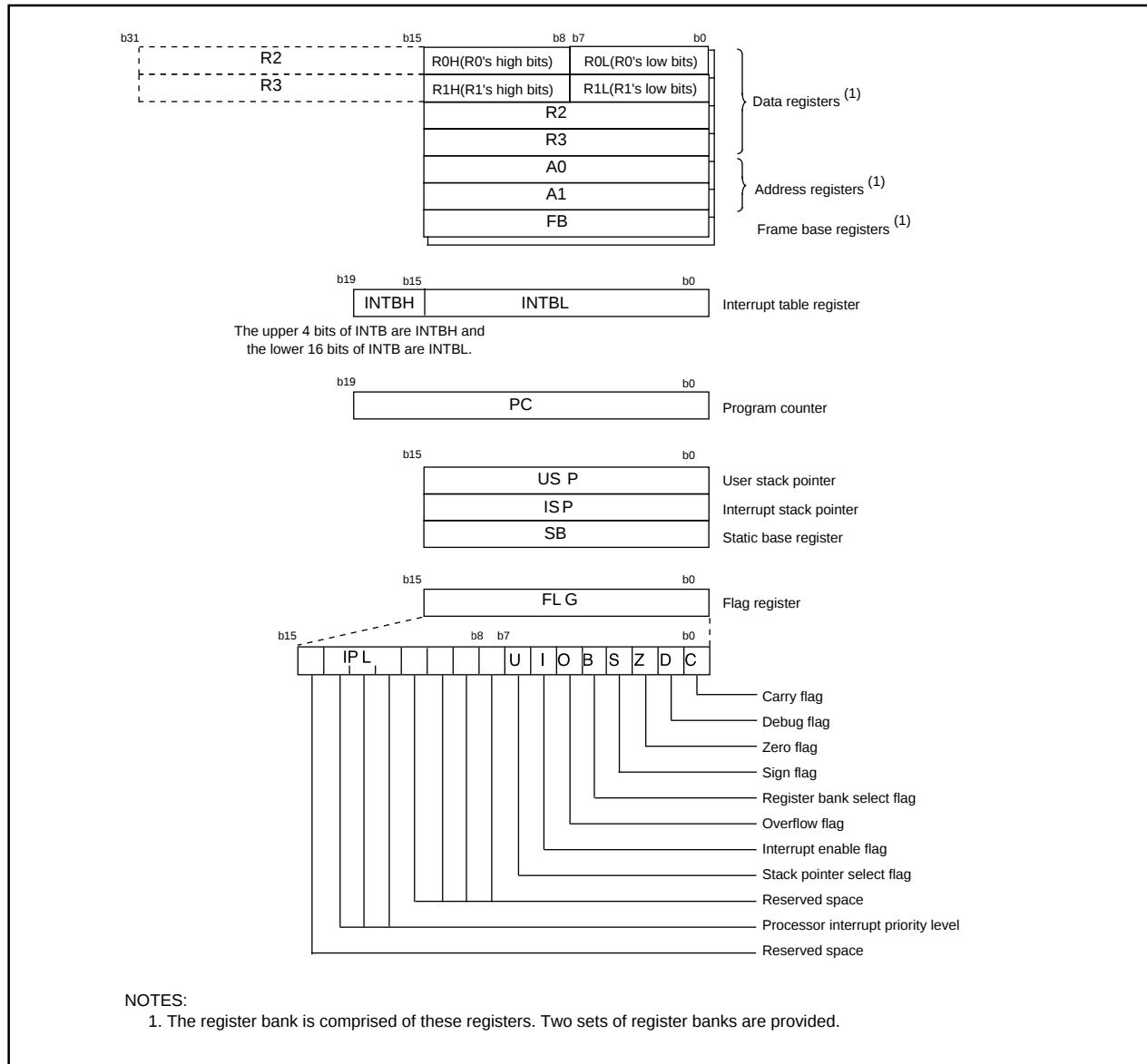


Figure 2.1 Central Processing Unit Register

2.1 Data Registers (R0, R1, R2 and R3)

The R0, R1, R2 and R3 registers are 16 bit registers for transfer and arithmetic/logic operations.

The R0 and R1 registers can be split into high-order bits(R0H, R1H) and low-order bits (R0L, R1L) to be used separately as 8-bit data registers. Conversely, R2 and R0 can be combined with R2 to be used as a 32-bit data register (R2R0). The same applies to R1 and R2.

2.2 Address Registers (A0 and A1)

The register A0 consists of 16 bits, and is used for address register indirect addressing and address register relative addressing. They also are used for transfers and arithmetic/logic operations. A1 is the same as A0. In some instructions, registers A1 and A0 can be combined for use as a 32-bit address register (A1A0).

4. Special Function Register (SFR)

SFR (Special Function Register) is the control register of peripheral functions. **Tables 4.1 to 4.7** list the SFR information.

Table 4.1 SFR Information⁽¹⁾

Address	Register	Symbol	After Reset
0000 ₁₆			
0001 ₁₆			
0002 ₁₆			
0003 ₁₆			
0004 ₁₆	Processor mode register 0	PM0	0016
0005 ₁₆	Processor mode register 1	PM1	000010002
0006 ₁₆	System clock control register 0	CM0	010010002
0007 ₁₆	System clock control register 1	CM1	001000002
0008 ₁₆			
0009 ₁₆	Address match interrupt enable register	AIER	XXXXXX002
000A ₁₆	Protect register	PRCR	XX0000002
000B ₁₆			
000C ₁₆	Oscillation stop detection register ⁽²⁾	CM2	0X0000102
000D ₁₆			
000E ₁₆	Watchdog timer start register	WDTS	XX16
000F ₁₆	Watchdog timer control register	WDC	00XXXXXX2
0010 ₁₆	Address match interrupt register 0	RMAD0	0016
0011 ₁₆			0016
0012 ₁₆			X016
0013 ₁₆			
0014 ₁₆	Address match interrupt register 1	RMAD1	0016
0015 ₁₆			0016
0016 ₁₆			X016
0017 ₁₆			
0018 ₁₆			
0019 ₁₆	Voltage detection register 1 ⁽³⁾	VCR1	000010002
001A ₁₆	Voltage detection register 2 ⁽³⁾	VCR2	0016
001B ₁₆			
001C ₁₆	PLL control register 0	PLC0	0001X0102
001D ₁₆			
001E ₁₆	Processor mode register 2	PM2	XXX000002
001F ₁₆	Low voltage detection interrupt register	D4INT	0016
0020 ₁₆	DMA0 source pointer	SAR0	XX16
0021 ₁₆			XX16
0022 ₁₆			XX16
0023 ₁₆			
0024 ₁₆	DMA0 destination pointer	DAR0	XX16
0025 ₁₆			XX16
0026 ₁₆			XX16
0027 ₁₆			
0028 ₁₆	DMA0 transfer counter	TCR0	XX16
0029 ₁₆			XX16
002A ₁₆			
002B ₁₆			
002C ₁₆	DMA0 control register	DM0CON	00000X002
002D ₁₆			
002E ₁₆			
002F ₁₆			
0030 ₁₆	DMA1 source pointer	SAR1	XX16
0031 ₁₆			XX16
0032 ₁₆			XX16
0033 ₁₆			
0034 ₁₆	DMA1 destination pointer	DAR1	XX16
0035 ₁₆			XX16
0036 ₁₆			XX16
0037 ₁₆			
0038 ₁₆	DMA1 transfer counter	TCR1	XX16
0039 ₁₆			XX16
003A ₁₆			
003B ₁₆			
003C ₁₆	DMA1 control register	DM1CON	00000X002
003D ₁₆			
003E ₁₆			
003F ₁₆			

NOTES:

1. The blank spaces are reserved. No access is allowed.
2. The CM20, CM21, and CM27 bits do not change at oscillation stop detection reset.
3. This register does not change at software reset, watchdog timer reset and oscillation stop detection reset.

X : Undefined

Table 4.3 SFR Information(3)(1)

Address	Register	Symbol	After Reset
01B0 ₁₆			
01B1 ₁₆			
01B2 ₁₆			
01B3 ₁₆	Flash memory control register 4 ⁽²⁾	FMR4	010000002
01B4 ₁₆			
01B5 ₁₆	Flash memory control register 1 ⁽²⁾	FMR1	000XX0X2
01B6 ₁₆			
01B7 ₁₆	Flash memory control register 0 ⁽²⁾	FMR0	000000012
01B8 ₁₆			
01B9 ₁₆			
0210 ₁₆	Low-power Consumption Control 0	LPCC0	X00000012
0211 ₁₆			
0212 ₁₆			
0213 ₁₆			
0214 ₁₆			
0215 ₁₆			
0216 ₁₆			
0217 ₁₆			
0218 ₁₆			
0219 ₁₆			
0250 ₁₆			
0251 ₁₆			
0252 ₁₆			
0253 ₁₆			
0254 ₁₆			
0255 ₁₆			
0256 ₁₆			
0257 ₁₆			
0258 ₁₆			
0259 ₁₆			
025A ₁₆			
025B ₁₆			
025C ₁₆	On-chip oscillator control register	ROCR	X00001012
025D ₁₆	Pin assignment control register	PACR	0016
025E ₁₆	Peripheral clock select register	PCLKR	000000112
025F ₁₆	Low-power Consumption Control 1	LPCC1	0016
02E0 ₁₆	I ² C0 data shift register	S00	XX16
02E1 ₁₆			
02E2 ₁₆	I ² C0 address register	S0D0	0016
02E3 ₁₆	I ² C0 control register 0	S1D0	0016
02E4 ₁₆	I ² C0 clock control register	S20	0016
02E5 ₁₆	I ² C0 start/stop condition control register	S2D0	000110102
02E6 ₁₆	I ² C0 control register 1	S3D0	001100002
02E7 ₁₆	I ² C0 control register 2	S4D0	0016
02E8 ₁₆	I ² C0 status register	S10	0001000X2
02E9 ₁₆			
02EA ₁₆			
02FE ₁₆			
02FF ₁₆			

Note 1: The blank spaces are reserved. No access is allowed.

Note 2: This register is included in the flash memory version.

X : Undefined

Table 4.5 SFR Information(5)(1)

Address	Register	Symbol	After Reset
0340 ₁₆			
0341 ₁₆			
0342 ₁₆	Timer A1-1 register	TA11	XX16
0343 ₁₆			XX16
0344 ₁₆	Timer A2-1 register	TA21	XX16
0345 ₁₆			XX16
0346 ₁₆	Timer A4-1 register	TA41	XX16
0347 ₁₆			XX16
0348 ₁₆	Three-phase PWM control register 0	INVC0	0016
0349 ₁₆	Three-phase PWM control register 1	INVC1	0016
034A ₁₆	Three-phase output buffer register 0	IDB0	001111112
034B ₁₆	Three-phase output buffer register 1	IDB1	001111112
034C ₁₆	Dead time timer	DTT	XX16
034D ₁₆	Timer B2 interrupt occurrence frequency set counter	ICTB2	XX16
034E ₁₆	Position-data-retain function control register	PDRF	XXXX00002
034F ₁₆			
0350 ₁₆			
0351 ₁₆			
0352 ₁₆			
0353 ₁₆			
0354 ₁₆			
0355 ₁₆			
0356 ₁₆			
0357 ₁₆			
0358 ₁₆			
0359 ₁₆			
035A ₁₆			
035B ₁₆			
035C ₁₆			
035D ₁₆			
035E ₁₆	Interrupt request cause select register 2	IFSR2A	00XXXXX02 ⁽²⁾
035F ₁₆	Interrupt request cause select register	IFSR	0016
0360 ₁₆	SI/O3 transmit/receive register	S3TRR	XX16
0361 ₁₆			
0362 ₁₆	SI/O3 control register	S3C	010000002
0363 ₁₆	SI/O3 bit rate generator	S3BRG	XX16
0364 ₁₆	SI/O4 transmit/receive register	S4TRR	XX16
0365 ₁₆			
0366 ₁₆	SI/O4 control register	S4C	010000002
0367 ₁₆	SI/O4 bit rate generator	S4BRG	XX16
0368 ₁₆			
0369 ₁₆			
036A ₁₆			
036B ₁₆			
036C ₁₆			
036D ₁₆			
036E ₁₆			
036F ₁₆			
0370 ₁₆			
0371 ₁₆			
0372 ₁₆			
0373 ₁₆			
0374 ₁₆	UART2 special mode register 4	U2SMR4	0016
0375 ₁₆	UART2 special mode register 3	U2SMR3	000X0X0X2
0376 ₁₆	UART2 special mode register 2	U2SMR2	X00000002
0377 ₁₆	UART2 special mode register	U2SMR	X00000002
0378 ₁₆	UART2 transmit/receive mode register	U2MR	0016
0379 ₁₆	UART2 bit rate generator	U2BRG	XX16
037A ₁₆	UART2 transmit buffer register	U2TB	XX16
037B ₁₆			XX16
037C ₁₆	UART2 transmit/receive control register 0	U2C0	000010002
037D ₁₆	UART2 transmit/receive control register 1	U2C1	000000102
037E ₁₆	UART2 receive buffer register	U2RB	XX16
037F ₁₆			XX16

Note 1: The blank spaces are reserved. No access is allowed.

Note 2: Write 1 to bit 0 after reset.

X : Undefined

Table 4.7 SFR Information(7)(1)

Address	Register	Symbol	After Reset
03C0 ₁₆ 03C1 ₁₆	A/D register 0	AD0	XX ₁₆ XX ₁₆
03C2 ₁₆ 03C3 ₁₆	A/D register 1	AD1	XX ₁₆ XX ₁₆
03C4 ₁₆ 03C5 ₁₆	A/D register 2	AD2	XX ₁₆ XX ₁₆
03C6 ₁₆ 03C7 ₁₆	A/D register 3	AD3	XX ₁₆ XX ₁₆
03C8 ₁₆ 03C9 ₁₆	A/D register 4	AD4	XX ₁₆ XX ₁₆
03CA ₁₆ 03CB ₁₆	A/D register 5	AD5	XX ₁₆ XX ₁₆
03CC ₁₆ 03CD ₁₆	A/D register 6	AD6	XX ₁₆ XX ₁₆
03CE ₁₆ 03CF ₁₆	A/D register 7	AD7	XX ₁₆ XX ₁₆
03D0 ₁₆ 03D1 ₁₆			
03D2 ₁₆	A/D trigger control register	ADTRGCON	00 ₁₆
03D3 ₁₆	A/D convert status register 0	ADSTAT0	00000X00 ₂
03D4 ₁₆ 03D5 ₁₆	A/D control register 2	ADCON2	00 ₁₆
03D6 ₁₆	A/D control register 0	ADCON0	00000XXX ₂
03D7 ₁₆ 03D8 ₁₆	A/D control register 1	ADCON1	00 ₁₆
03D9 ₁₆ 03DA ₁₆			
03DB ₁₆ 03DC ₁₆			
03DD ₁₆ 03DE ₁₆			
03DF ₁₆			
03E0 ₁₆	Port P0 register	P0	XX ₁₆
03E1 ₁₆	Port P1 register	P1	XX ₁₆
03E2 ₁₆ 03E3 ₁₆	Port P0 direction register	PD0	00 ₁₆
03E4 ₁₆	Port P1 direction register	PD1	00 ₁₆
03E5 ₁₆	Port P2 register	P2	XX ₁₆
03E6 ₁₆	Port P3 register	P3	XX ₁₆
03E7 ₁₆	Port P2 direction register	PD2	00 ₁₆
03E8 ₁₆	Port P3 direction register	PD3	00 ₁₆
03E9 ₁₆ 03EA ₁₆			
03EB ₁₆			
03EC ₁₆	Port P6 register	P6	XX ₁₆
03ED ₁₆	Port P7 register	P7	XX ₁₆
03EE ₁₆	Port P6 direction register	PD6	00 ₁₆
03EF ₁₆	Port P7 direction register	PD7	00 ₁₆
03F0 ₁₆ 03F1 ₁₆	Port P8 register	P8	XX ₁₆
03F2 ₁₆	Port P9 register	P9	XX ₁₆
03F3 ₁₆	Port P8 direction register	PD8	00 ₁₆
03F4 ₁₆	Port P9 direction register	PD9	000X0000 ₂
03F5 ₁₆	Port P10 register	P10	XX ₁₆
03F6 ₁₆	Port P10 direction register	PD10	00 ₁₆
03F7 ₁₆ 03F8 ₁₆			
03F9 ₁₆ 03FA ₁₆			
03FB ₁₆			
03FC ₁₆	Pull-up control register 0	PUR0	00 ₁₆
03FD ₁₆	Pull-up control register 1	PUR1	00 ₁₆
03FE ₁₆	Pull-up control register 2	PUR2	00 ₁₆
03FF ₁₆	Port control register	PCR	00 ₁₆

Note 1: The blank spaces are reserved. No access is allowed.

X : Undefined

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